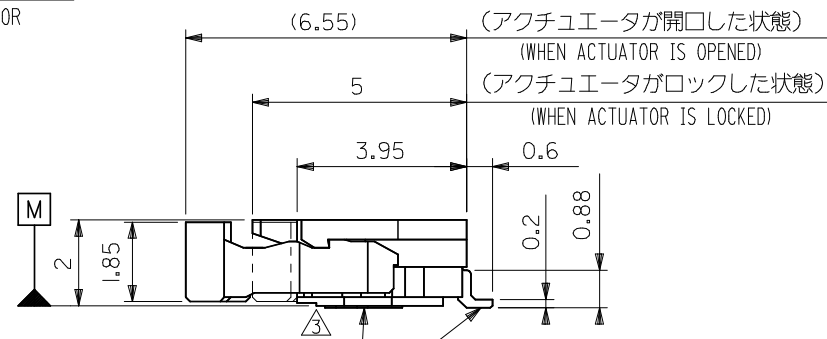
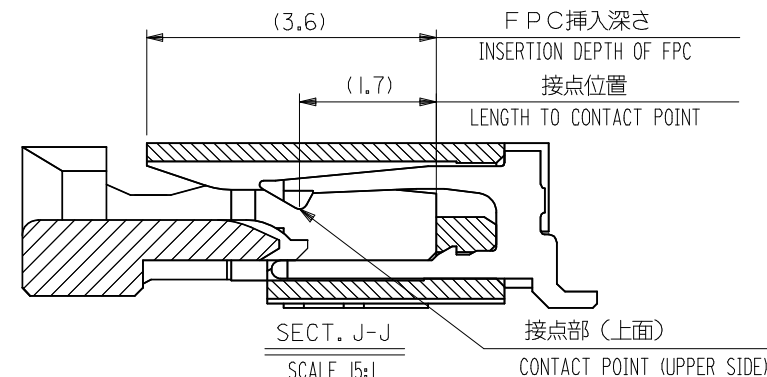
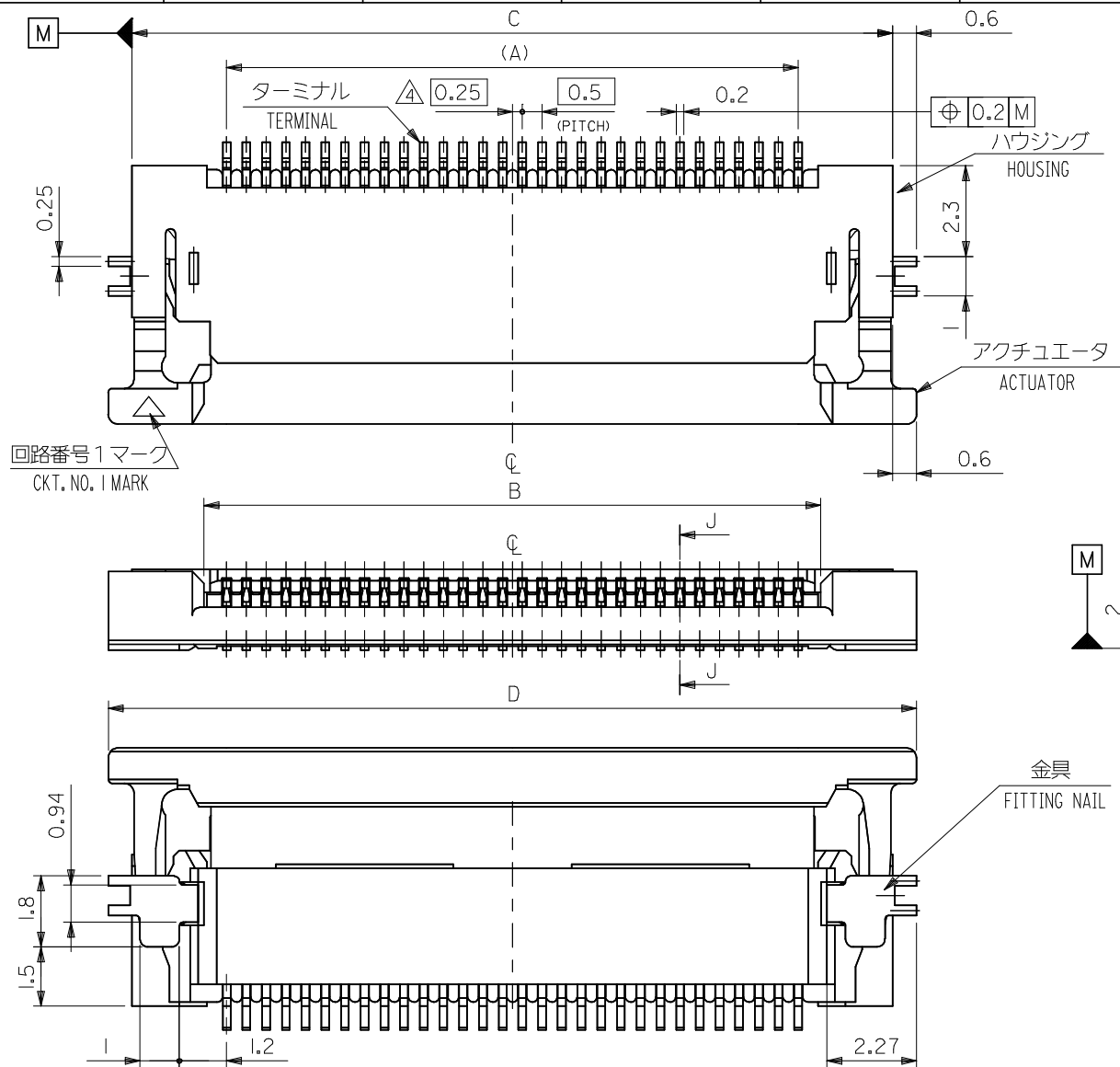
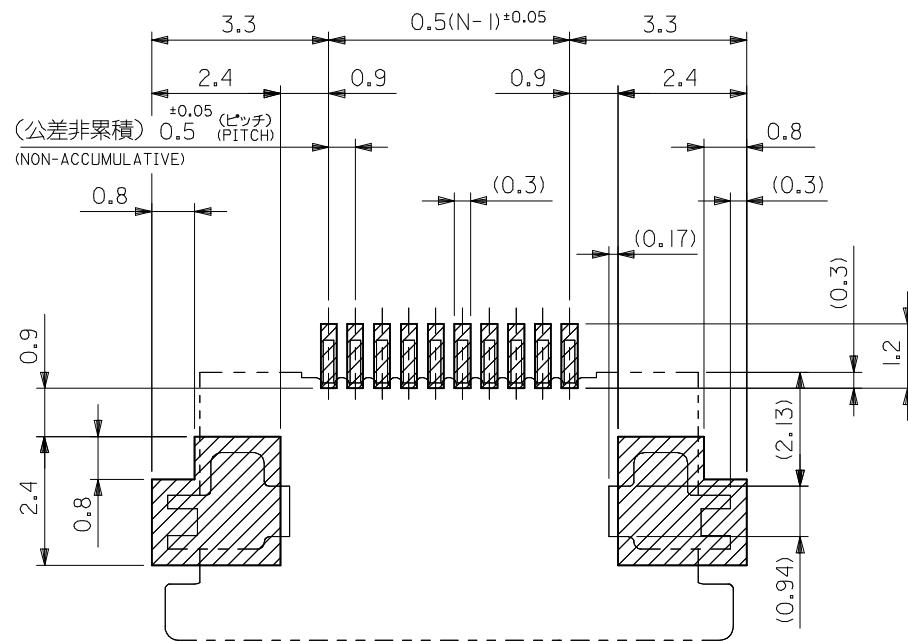


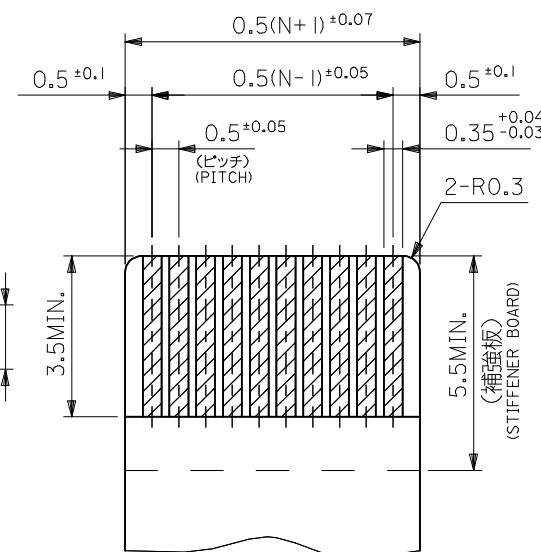


30.5	29.3	25.65	24.5	54104-5096	54104 - 5039	50
28.5	27.3	23.65	22.5	54104-4696	54104 - 4639	46
28.0	26.8	23.15	22.0	54104-4596	54104 - 4539	45
27.0	25.8	22.15	21.0	54104-4396	54104 - 4339	43
25.5	24.3	20.65	19.5	54104-4096	54104 - 4039	40
24.5	23.3	19.65	18.5	54104-3896	54104 - 3839	38
23.5	22.3	18.65	17.5	54104-3696	54104 - 3639	36
23.0	21.8	18.15	17.0	54104-3596	54104 - 3539	35
22.5	21.3	17.65	16.5	54104-3496	54104 - 3439	34
22.0	20.8	17.15	16.0	54104-3396	54104 - 3339	33
21.5	20.3	16.65	15.5	54104-3296	54104 - 3239	32
20.5	19.3	15.65	14.5	54104-3096	54104 - 3039	30
D	C	B	A	EMBOSSED TAPE	MATERIAL NO.	CIRCUIT
				ORDER No. オーダー番号		

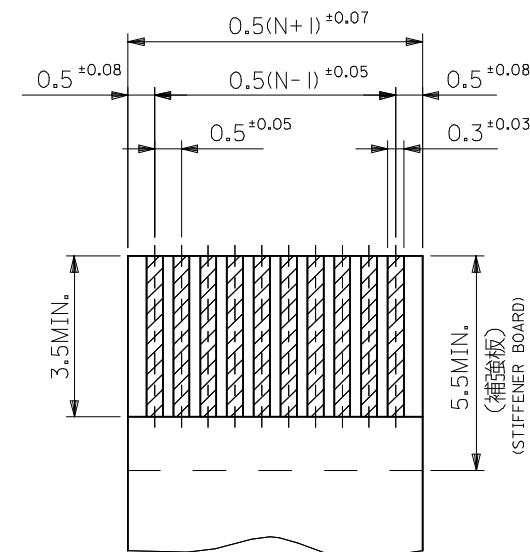
REVISED EC NO: J2008-4308 DRWN:MMABEI CHKD:THARIYAMA APPR:NUKITA	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
				MM ONLY		---	METRIC		
		10 UNDER	± 0.2	DRAWN BY Y. SAKIYAMA	DATE '04/01/22	TITLE 0.5 FPC CONN ZIF HSG ASSY FOR SMT RA UPR CONT -LEAD FREE-			
		10 OVER 30 UNDER	± 0.25	CHECKED BY M. SASAO	DATE '04/01/22				
		30 OVER	± 0.3	APPROVED BY M. SASAO	DATE '04/01/22	molex MOLEX INCORPORATED			
		ANGULAR ±3 °	MATERIAL NO.		DOCUMENT NO.				
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	SEE TABLE THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
		SD-54104-071				1 OF 2			



コネクタ位置
CONNECTOR POSITION



適合FPC推奨寸法
APPLICABLE FPC
RECOMMENDED DIMENSION
(仕上がり厚さ: 0.3^{±0.03})
(THICKNESS: 0.3^{±0.03})



適合FFC推奨寸法
APPLICABLE FFC
RECOMMENDED DIMENSION

(仕上がり)厚さ: $0.3^{+0.03}$
(THICKNESS: $0.3^{+0.03}$)

注記 NOTES

I. 使用材料 MATERIAL

ハウジング : 46ナイロン、UL94V-0
HOUSING 46NYLON

アクチュエータ : PPS、UL94V-0
ACTUATOR

ターミナル
TERMINAL :リン青銅、ニッケル下地 錫ビスマスメッキ (t=0.2)
PHOS-BRONZE, TIN-BISMUTH

金具 : リン青銅、ニッケル下地 錫メッキ (t=0.2)
FITTING NAIL PHOS-BRONZE, TIN OVER NICKEL PLATING. (t=0.2)

参考基板レイアウト
RECOMMENDED P.C.BOARD
PATTERN DIMENSION (REF.)

(マウント面)
(MOUNTING SIDE)

2. エンボステーパ梱包時は、アクチュエータがロックした状態とする。
IN THE PACKAGE,ACTUATOR OF PART NO.54104-**39 SHOULD BE LOCKED.

△3 ソルダータール半田付け面のズレ量、及び金具半田付け面のズレ量は、基準面 H に対し上方向 0.1 MAX. 下方向 0.15 MAX. とし、相互のパラッキ量は、0.1 MAX. とする。
MISALIGNMENT OF SOLDER TAILS AND FITTING NAILS FROM H
UPPER DIRECTION: 0.1 MAX. , LOWER DIRECTION: 0.15 MAX.
OFFSET BETWEEN UPPER AND LOWER 0.1 MAX.

△ 偶数極に適用。
APPLY FOR EVEN CIRCUIT.

△ パターンはくり止め用金具
FITTING NAIL FOR PREVENTION OF PEELING OF P.C.B. PATTERN.

6. 本製品は 54104-**37 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 54104-**37.

FPC/FFCについて

打抜き方向は導体側から補強板側を推奨いたします。

導体部については軟銅箔35マイクロメートルまたは50マイクロメートル
メッキ厚 3~9マイクロメートル錫または半田メッキ（電気メッキ）

RECOMMENDED PUNCHER DIRECTION:
FROM CONDUCTOR SIDE TO STIFFENER BOARD SIDE.
RECOMMENDED CONDUCTOR SPEC.:
THICKNESS OF SOFT COPPER FOIL:
35 micrometer or 50 micrometer
TIN OR SOLDER PLATING:
3 ~9 micrometer(ELECTRICAL PLATING)

FPCについて

補強フィルム材質はポリイミドを推奨致します。

接着剤は熱硬化接着剤を推奨致します。

RECOMMENDED MATERIAL:
STIFFENER FILM : POLYIMIDE
BONDING AGENT : THERMOSETTING BONDING AGENT

FREE OF 54104-***37.		54104-***39		MODEL NO.	
GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC
				THIRD ANGLE PROJECTION	
DRAWN BY: 2008/06/27 CHK'D BY: 2008/06/30 APPR: 2008/06/30		TITLED		0.5 FPC CONN ZIF HSG ASSY FOR SMT RA UPR CONT -LEAD FREE-	
10 UNDER ± 0.2		Y. SAKIYAMA '04/01/22		MOLEX MOLEX INCORPORATED	
10 OVER 30 UNDER ± 0.25		CHECKED BY: DATE M. SASAO '04/01/22			
30 OVER ± 0.3		APPROVED BY: DATE M. SASAO '04/01/22			
ANGULAR ± 3 °		MATERIAL NO.		DOCUMENT NO.	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 1		SD-54104-071	
REV		SIZE		SHEET NO.	
A		A 3		2 OF 2	
REVISED		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

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F

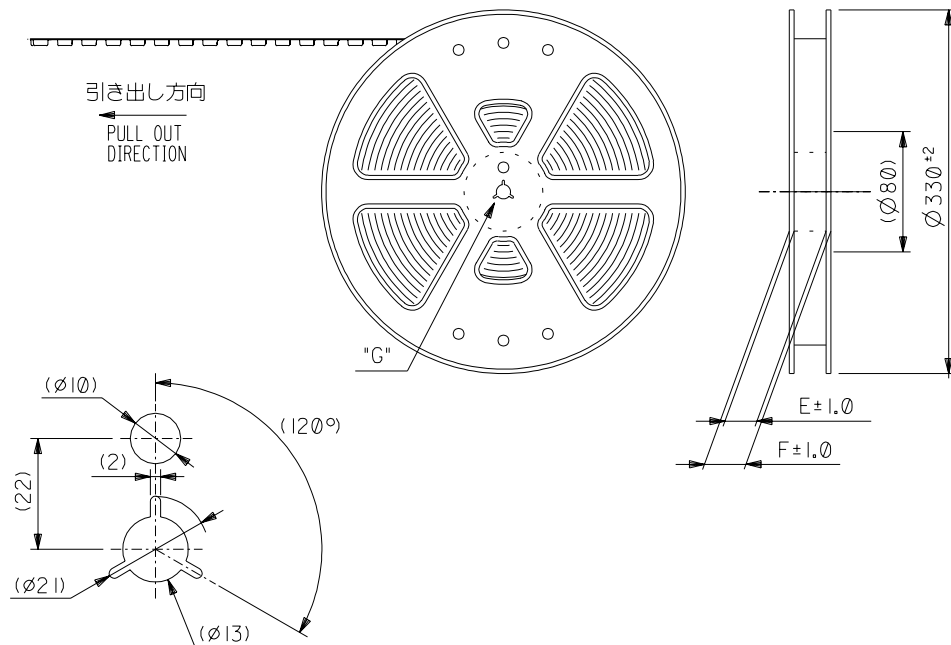
E

D

C

B

A



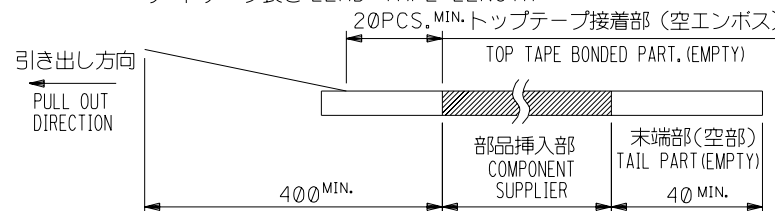
DETAIL "G"

4. 材料(MATERIAL)
キャリアテープ(CARRIER TAPE): ポリプロピレン(POLYPROPYLENE)
トップテープ(TOPTAPE): PET, PE, PEF
リール(REEL): ポリスチレン(PS)<リサイクル材を含む>
POLYSTYRENE (PS) <RECYCLE MATERIAL CONTAINED>

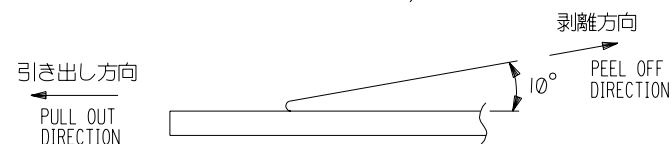
5. 本製品は 54104-***92 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 54104-***92.

NOTES

1. 梱包数量: 1500個/リール
NUMBER OF CONNECTORS: 1500PCS/REEL
2. リードテープ長さ LEAD TAPE LENGTH

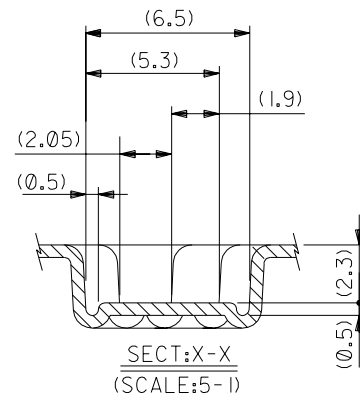


3. トップテープの剥離強度: 0.1 ~ 1.3N (10 ~ 130gf)
(剥離方向は下図参照)
尚、本規格値は出荷時に適用。(但し、輸送時に剥離が発生しないこと。)
PEELING OFF FORCE OF TOP TAPE: 0.1 ~ 1.3N (10 ~ 130gf)
(PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)
THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT.
PEEL OFF SHOULD NOT BE ALLOWED, DURING TRANSPORTATION.



44	49.4	45.4	30.8	31.9	26.1	29.6	54104-5096	50	
			28.8	29.9	24.1	27.6	4	-4696	46
			28.3	29.4	23.6	27.1	4	-4596	45
			27.3	28.4	22.6	26.1		-4396	43
			25.8	26.9	21.1	24.6		-4096	40
			24.8	25.9	20.1	23.6		-3896	38
			23.8	24.9	19.1	22.6		-3696	36
			23.3	24.4	18.6	22.1		-3596	35
			22.8	23.9	18.1	21.6		-3496	34
			22.3	23.4	17.6	21.1		-3396	33
			21.8	22.9	17.1	20.6	7	-3296	32
			20.8	21.9	16.1	19.6	54104-3096	30	
キャリアテープ幅 CARRIER TAPE WIDTH	F	E	D	C	B	A	MATERIAL NO.	CIRCUIT	

EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	REVISED '04/04/21 EC NO. J2004-3918 DRWN: Y.WADA CHK: M.SASAO APPR: M.SASAO	RELEASED '04/01/22 EC NO. J2004-2032 DRWN: Y.SAKIYAMA CHK: M.SASAO APPR: M.SASAO	DESCRIPTION REV	MATERIAL 材料	注記参照 SEE NOTES	GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差	SCALE —	DESIGN UNITS ☒ mm ☐ INCH	THIRD ANGLE PROJECTION	☐ mm INCH ☐ mm ☒ mm ONLY	REVISE ON CAD ONLY	
						10 UNDER 未満		±0.2	DRAWN BY & DATE Y.SAKIYAMA '04/01/22	TITLE: Embstp Pkg for 0.5 FPC Conn Zif Hsg Assy -LEAD FREE-				
						10 OVER 以上 30 UNDER 未満		±0.25	CHECKED BY & DATE M.SASAO '04/01/22					
						30 OVER 以上		±0.3	APPROVED BY & DATE M.SASAO '04/01/22		 MOLEX INCORPORATED			
						WIRE RANGE 適用電線範囲	—	ANGLE 角度	3°	CAD FILENAME SD-54104-072.S01	MATERIAL NO. SEE CHART	DRAWING NO. SD-54104-072	SHEET NO. 1 OF 2	
						INS. RANGE 被覆外径	—	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.						SIZE B



EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	REVISED '04/04/21 EC NO. J2004-3918 DRWN: Y.WADA CHK: M.SASAO APPR: M.SASAO	RELEASED '04/01/22 EC NO. J2004-2032 DRWN: Y.SAKIYAMA CHK: M.SASAO APPR: M.SASAO	DESCRIPTION	MATERIAL 材料	SHEET 1 OF 2 参照 REFER TO SHEET 1 OF 2	GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差	SCALE	MODEL NO.	54104-***96	DIMENSIONS:		SHT	REV
						DESIGN UNITS mm INCH			☒ mm ☐ INCH	☐ mm ☐ INCH ☒ mm ONLY	THIRD ANGLE PROJECTION	REVISE ON CAD ONLY			
						10 UNDER 未満			±0.2	TITLE: Embstp Pkg for 0.5 FPC Conn Zif Hsg Assy -LEAD FREE-					
						10 OVER 以上			30 UNDER 未満						±0.25
FINISH 仕上り	— # —	30 OVER 以上	±0.3	APPROVED BY & DATE M.SASAO '04/01/22	MOLEX INCORPORATED										
WIRE RANGE 適用電線範囲	— # —	ANGLE 角度	±3°	CAD FILENAME SD-54104-072.S02	MATERIAL NO. SEE CHART	DRAWING NO. SD-54104-072	SHEET NO. 2 OF 2		SIZE B						
INS. RANGE 被覆外径	— # —	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.													